



RS1GT08 Single 2-Input Positive-AND Gate

1 FEATURES

- Operating Voltage Range: 2.0V to 5.5V
- Low Power Consumption: 1μA (Max)
- Operating Temperature Range: -40°C to +125°C
- Inputs Are TTL-Voltage Compatible
- High Output Drive: ±32mA at Vcc=5.0V
- Micro SIZE PACKAGES: SOT23-5, SC70-5

2 APPLICATIONS

- Active Noise Elimination
- Bar Code Scanner
- Blood Pressure Monitor
- CPAP Machine
- Fingerprint identification
- Network attached storage (NAS)

The RS1GT08 single 2-input positive-AND gate is designed for 2.0 to $5.5V\ V_{CC}$ operation.

The RS1GT08 device performs the Boolean function Y=A \bullet B or Y= \overline{A} + \overline{B} in positive logic. The device is fully specified for partial-power-down applications using loff. The loff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The RS1GT08 is available in Green SOT23-5 and SC70-5 packages. It operates over an ambient temperature range of -40°C to +125°C.

Device Information (1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)		
DC4CT00	SOT23-5	2.92mm×1.60mm		
RS1GT08	SC70-5	2.10mm×1.25mm		

(1) For all available packages, see the orderable addendum at the end of the data sheet.

LOGIC SYMBOL



4 FUNCTION TABLE

3 DESCRIPTIONS

INP	OUTPUT	
Α	В	Υ
Н	Н	Н
L	Н	L
Н	L	L
L	L	L

Y=A•B H=High Voltage Level L=Low Voltage Level



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5 Revision HistoryNote: Page numbers for previous revisions may different from page numbers in the current version.

Version	Change Date	Change Item		
A.1	2023/03/27	Initial version completed		
A.2	2023/11/02	Added Marking Information on Page 4@RevA.1		
A.2.1	2024/02/29	Modify packaging naming		



6 PACKAGE/ORDERING INFORMATION (1)

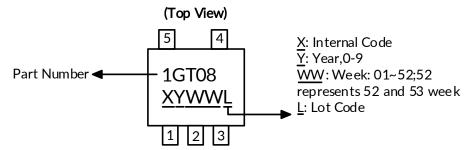
PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING (2)	MSL ⁽³⁾	PACKAGE OPTION
DC1CTO0	RS1GT08XF5	-40°C ~+125°C	SOT23-5	1GT08	MSL3	Tape and Reel,3000
RS1GT08	RS1GT08XC5	-40°C ~+125°C	SC70-5 (4)	1GT08	MSL3	Tape and Reel,3000

NOTE:

- (1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.
- (2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.
- (3) MSL, The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications.
- (4) Equivalent to SOT353.

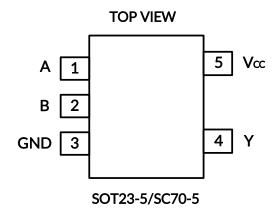
Marking Information

(1) SOT23-5, SC70-5





7 PIN CONFIGURATIONS



PIN DESCRIPTION

PIN	NAME	I/O (1)	FUNCTION	
SOT23-5/SC70-5	NAME	1/0 \-/	FORCTION	
1	Α	I	Input	
2	В	I	Input	
3	GND	Р	Ground	
4	Υ	0	Output	
5	V _{CC}	Р	Power pin	

⁽¹⁾ I=input, O=output, P=power.



8 SPECIFICATIONS

8.1 Absolute Maximum Ratings (1)

over operating free-air temperature range (unless otherwise noted) (1) (2)

			MIN	MAX	UNIT
Vcc	Supply voltage range		-0.5	6.5	V
Vı	Input voltage range (2)		-0.5	6.5	V
Vo	Voltage range applied to any output in the high-impe	dance or power-off state (2)	-0.5	6.5	V
Vo	Vo Voltage range applied to any output in the high or low state (2) (3)			Vcc+0.5	V
lıĸ	Input clamp current V _I <0			-50	mA
lok	Output clamp current		-50	mA	
lo	Continuous output current		±50	mA	
	Continuous current through V _{CC} or GND			±100	mA
0	Declare the world improduce (4)	SOT23-5		230	°C/W
Αιθ	Package thermal impedance ⁽⁴⁾			376	-C/VV
ΤJ	Junction temperature (5)	-65	150	°C	
Tstg	stg Storage temperature			150	°C

⁽¹⁾ Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of V_{CC} is provided in the *Recommended Operating Conditions table*.
- (4) The package thermal impedance is calculated in accordance with JESD-51.
- (5) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.

8.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

		VALUE	UNIT
	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	V
V _(ESD) Electrostatic discharge	Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 ⁽²⁾	±1000	V
	Machine model (MM)	±200	V

- (1) JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process.



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

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9 ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (TYP values are at T_A = +25°C, Full=-40°C to 125°C, unless otherwise noted.) (1)

9.1 Recommended Operating Conditions

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
Supply voltage	Vcc	Operating	2.0	5.5	V
		V _{CC} =2.0V	1.0		
High-level input voltage	V _{IH}	V _{CC} =3.3V	1.5		V
		V _{CC} =4.5V to 5.5V	2.0		
		V _{CC} =2.0V		0.3	
Low-level input voltage	VIL	V _{CC} =3.3V		0.55	V
		V _{CC} =4.5V to 5.5V		0.8	
Input voltage	Vı		0	5.5	V
Output voltage	Vo		0	Vcc	V
Input transition rise or fall	Δt/Δν	V _{CC} =2.0V to 5.5V		5	ns/V
Operating temperature	T _A		-40	+125	°C

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

9.2 DC Characteristics

PA	PARAMETER TEST CONDITIONS		Vcc	TEMP	MIN ⁽²⁾	TYP (3)	MAX ⁽²⁾	UNIT
		Ι _{ΟΗ} = -100μΑ	2.0V to 5.5V		V _{CC} -0.1			
		I _{OH} = -8mA	2.0		1.6			
	V	I _{OH} = -24mA	3.3	FII	2.5			
	Vон		4.5V	Full	3.8			V
		I _{OH} = -32mA	5V		4.2			
			5.5V		4.8			
		I _{OL} = 100μA	2.0V to 5.5V				0.1	
		I _{OH} = 8mA	2.0				0.45	V
	V	I _{OH} = 24mA	3.3	Full			0.55	
	Vol		4.5V				0.55	
		$I_{OL} = 32mA$	5V				0.5	
			5.5V				0.45	
,	A D :t-	V F EV CND	0)// 5.5)/	+25°C		±0.1	±1	
lı	A or B inputs	V _I =5.5V or GND	0V to 5.5V	Full			±5	μΑ
	Lu	Vior Vo=5.5V	0V	+25°C		±0.1	±1	
	I _{off} V _I or V _O =5.5V		00	Full			±10	μΑ
lcc		V = 5 5 V or CND 1 = 0	2.0V to 5.5V	+25°C		0.1	1	
		V_1 =5.5V or GND, I_0 =0	2.00 to 3.30	Full			10	μΑ
ICCT One input at 3.4V, Other inputs at V _{CC} or GND		5.5V	Full			500	μΑ	
C _i (Inpu	ıt Capacitance)	V _{CC} =0V, f=10MHz	0V	+25°C		6		pF

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

⁽²⁾ Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.

⁽³⁾ Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.



9.3 AC Characteristics

210 710 011011010110101							
PARAMETER	SYMBOL	TEST CO	MIN ⁽²⁾	TYP ⁽³⁾	MAX ⁽²⁾	UNIT	
		V _{CC} =2.0V±0.2V	C _L =30pF, R _L =500Ω		15.5		
Propagation Delay	t _{pd}	V _{CC} =3.3V±0.3V	C _L =50pF, R _L =500Ω		13.5		ns
		V _{CC} =5V±0.5 V	C _L =50pF, R _L =500Ω		4.1		
Power dissipation capacitance	C_{pd}	V _{CC} =5V	f=10MHz		22		pF

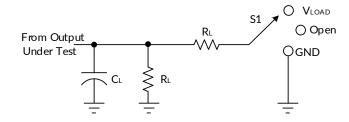
⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

⁽²⁾ This parameter is ensured by design and/or characterization and is not tested in production.

⁽³⁾ Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.

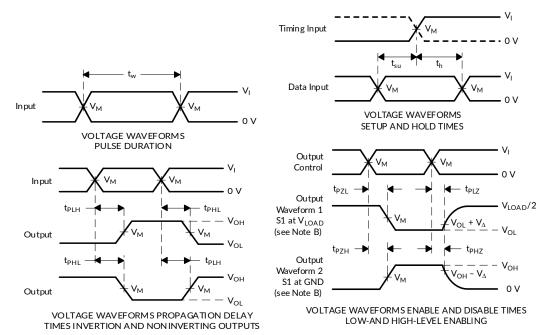


10 Parameter Measurement Information



TEST	S1
tplH/tpHL	Open
tplz/tpzl	V_{LOAD}
tрнz/tрzн	GND

V	INPUTS		V	V	C.	D.	VΔ	
Vcc	Vı	t _r /t _f	Vм	VLOAD	C∟	RL	VA	
2.0V±0.2V	V _{CC}	≤2ns	V _{CC} /2	2 x V _{CC}	30pF	500Ω	0.15V	
3.3V±0.3V	3V	≤2.5ns	1.5V	6V	50pF	500Ω	0.3V	
5V±0.5V	Vcc	≤2.5ns	Vcc/2	2 x Vcc	50pF	500Ω	0.3V	



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Zo = 50 Ω .
- D. The outputs are measured one at a time, with one transition per measurement.
- $E.\ t_{PLZ}$ and t_{PHZ} are the same as $t_{dis}.$
- F. t_{PZL} and t_{PZH} are the same as $t_{\text{en}}.$
- G. t_{PLH} and t_{PHL} are the same as $t_{\text{pd}}.$
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

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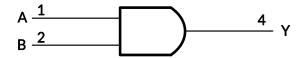


11 Detailed Description

11.1 Overview

The RS1GT08 device is a single 2-input positive-AND gate. The device performs the Boolean AND function (Y=A \bullet B or Y= $\overline{A}+\overline{B}$) in positive logic. Low lcc current allows this device to be used in power sensitive or battery-powered applications. Robust inputs allow the device to up-translate with a propagation delay of 4.1 ns.

11.2 Functional Block Diagram



11.3 Feature Description

- The V_{CC} for the device is optimized at 5 V.
- The inputs accept V_{IH} levels of 2 V.
- Output ringing is minimized by slow edge rates.
- Inputs are TTL-Voltage compatible.



12 Application and Implementation

Information in the following applications sections is not part of the RUNIC component specification, and RUNIC does not warrant its accuracy or completeness. RUNIC's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

12.1 Application Information

The RS1GT08 device is a single AND gate, which is often used for many common functions like power sequencing or an on LED indicator. Because the device is configured to output LOW unless all inputs are HIGH, an LED tied to the output of the device will only turn HIGH when all systems connected are sending a HIGH, or ready signal.

12.2 Design Requirements

This device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive also creates fast edges into light loads, so routing and load conditions must be considered to prevent ringing.

13 Power Supply Recommendations

The power supply pin should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, a 0.1 uF capacitor is recommended and if there are multiple V_{CC} terminals then 0.01 uF or 0.022 uF capacitors are recommended for each power terminal. It is acceptable to parallel multiple bypass caps to reject different frequencies of noise. The 0.1 uF and 1 uF capacitors are commonly used in parallel. The bypass capacitor should be installed as close to the power terminal as possible.

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14 Layout

14.1 Layout Guidelines

When using multiple bit logic devices inputs should not ever float. In many cases, functions or parts of functions of digital logic devices are unused; for example, when only two inputs of a triple-input AND gate are used or only 3 of the 4 buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. Specified below are the rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally, they will be tied to GND or Vcc whichever make more sense or is more convenient.

14.2 Layout Example

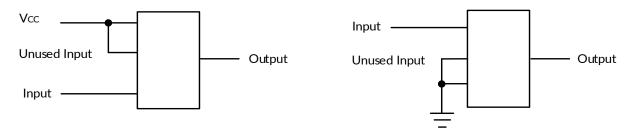
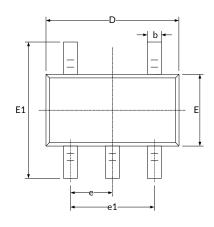
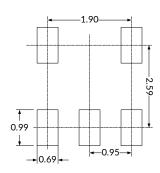


Figure 2. Layout Diagram

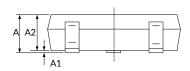


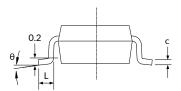
15 PACKAGE OUTLINE DIMENSIONS SOT23-5 (3)





RECOMMENDED LAND PATTERN (Unit: mm)





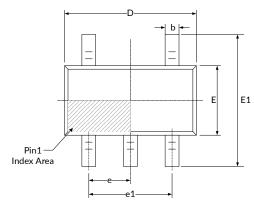
Complete	Dimensions I	n Millimeters	Dimensions In Inches			
Symbol	Min	Max	Min	Мах		
A (1)	1.050	1.250	0.041	0.049		
A1	0.000	0.100	0.000	0.004 0.045 0.020 0.008 0.119 0.067		
A2	1.050	1.150	0.041			
b	0.300	0.500	0.012			
С	0.100	0.200	0.004 0.111 0.059			
D ⁽¹⁾	2.820	3.020				
E ⁽¹⁾	1.500	1.700				
E1	2.650	2.950	0.104	0.116		
е	0.950(BSC) (2)	0.037(BSC) (2)			
e1	1.800	2.000	0.071	0.079 0.024 8°		
L	0.300	0.600	0.012			
θ	0°	8°	0°			

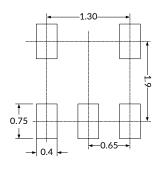
NOTE:

- Plastic or metal protrusions of 0.15mm maximum per side are not included.
 BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
 This drawing is subject to change without notice.

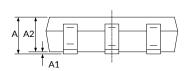


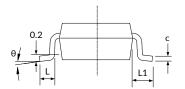
SC70-5 (3)





RECOMMENDED LAND PATTERN (Unit: mm)





Complete	Dimensions I	n Millimeters	Dimensions In Inches			
Symbol	Min	Max	Min	Max		
A (1)	0.900	1.100	0.035	0.043		
A1	0.000			0.004		
A2	0.900			0.039		
b	0.150	0.350	0.006	0.014 0.006 0.087		
С	0.080	0.150	0.003			
D ⁽¹⁾	2.000	2.200	0.079			
E (1)	1.150	1.350	0.045	0.053		
E1	2.150	2.450	0.085	0.096		
е	0.650(BSC) (2)	0.026(BSC) (2)			
e1	1.300(BSC) (2)	0.051(BSC) (2)			
L	0.260	0.460	0.010	0.018		
L1	0.5	525	0.021			
θ	0°	8°	0°	8°		

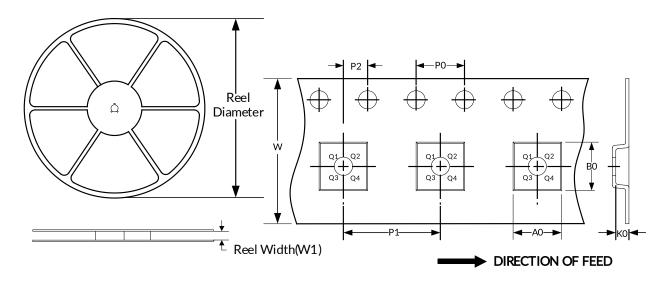
NOTE:

- 1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
- 2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.3. This drawing is subject to change without notice.



16 TAPE AND REEL INFORMATION REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width(mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SC70-5	7"	9.5	2.25	2.55	1.20	4.0	4.0	2.0	8.0	Q3
SOT23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3

NOTE:

- 1. All dimensions are nominal.
- 2. Plastic or metal protrusions of 0.15mm maximum per side are not included.



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